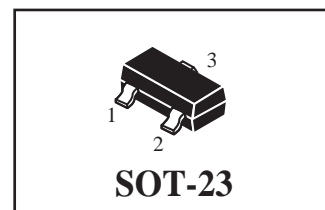
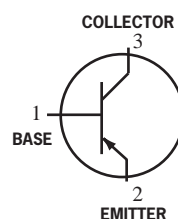


### Epitaxial Planar Transistor PNP Silicon

**(Pb)** Lead(Pb)-Free



#### MAXIMUM RATINGS (Ta=25 °C)

Rating	Symbol	Value	Unit
Collector-Emitter Voltage	V <sub>CEO</sub>	-20	Vdc
Collector-Base Voltage	V <sub>CBO</sub>	-30	Vdc
Emitter-Base Voltage	V <sub>EBO</sub>	-6.0	Vdc
Collector Current-Continuous	I <sub>C</sub>		mAdc

#### THERMAL CHARACTERISTICS

Characteristics	Symbol	Value	Unit
Total Device Dissipation FR-5 Board <sup>(1)</sup> T <sub>A</sub> =25 °C	P <sub>D</sub>	150	mW
Derate above 25 °C		0.5	mW/°C
Thermal Resistance, Junction Ambient	R <sub>θJA</sub>	833	°C/W
Junction and Storage, Temperature	T <sub>J</sub> , T <sub>stg</sub>	-55 to +150	°C

#### Device Marking

2SB1386=

#### ELECTRICAL CHARACTERISTICS

Characteristics	Symbol	Min	Max	Unit
Collector-Emitter Breakdown Voltage(I <sub>C</sub> =-1 mAdc, I <sub>B</sub> =0)	V <sub>(BR)CEO</sub>	-20	-	Vdc
Collector-Base Breakdown Voltage(I <sub>C</sub> =-50 uAdc, I <sub>E</sub> =0)	V <sub>(BR)CBO</sub>	-30	-	Vdc
Emitter-Base Breakdown Voltage(I <sub>E</sub> =-50 uAdc, I <sub>C</sub> =0)	V <sub>(BR)EBO</sub>	-6.0	-	Vdc
Collector Cutoff Current(V <sub>CB</sub> =-20Vdc, I <sub>E</sub> =0)	I <sub>CBO</sub>	-	-0.5	uAdc
Emitter Cutoff Current(V <sub>EB</sub> =-5Vdc, I <sub>C</sub> =0)	I <sub>EBO</sub>	-	-0.5	uAdc

1. FR-5=1.0×0.75×0.062 in

**ELECTRICAL CHARACTERISTICS** ( $T_A=25^{\circ}\text{C}$  unless otherwise noted) (Continued)

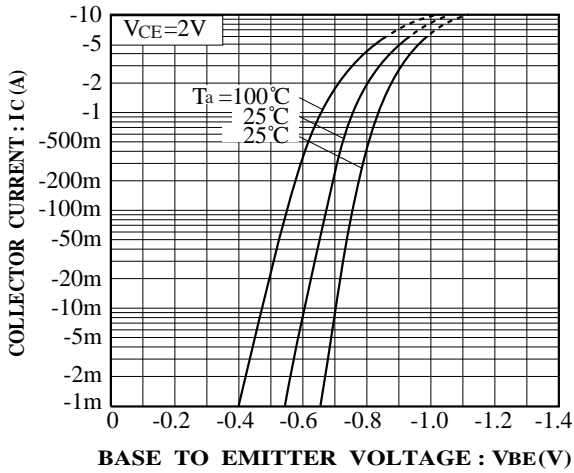
Characteristics	Symbol	Min	TYP	Max	Unit
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**ON CHARACTERISTICS**

DC Current Gain ( $I_C = -0.5 \text{ Adc}, V_{CE} = -2.0 \text{ Vdc}$ )	hFE	82	-	390	-
Transition Frequency ( $I_E = 50 \text{ mAdc}, V_{CE} = -6.0 \text{ Vdc}, f=30\text{MHz}$ )	fT	-	120	-	Vdc
Output Capacitance ( $I_E = 0 \text{ Adc}, V_{CB} = -20 \text{ Vdc}, f=1\text{MHz}$ )	Cob	-	60	-	pF

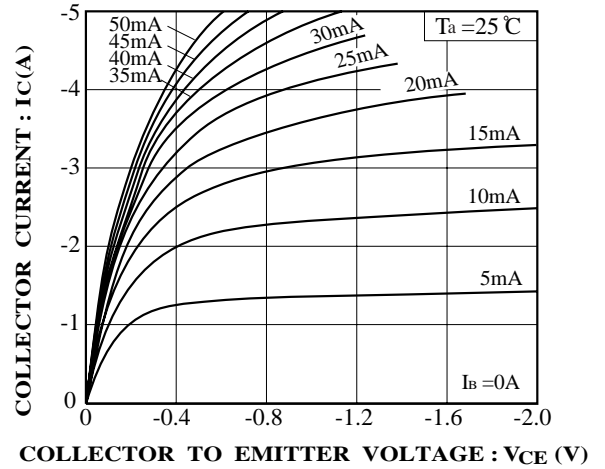
**Classification of hFE**

Rank	P	Y	G
Range	82-180	120-270	180-390
Marking			



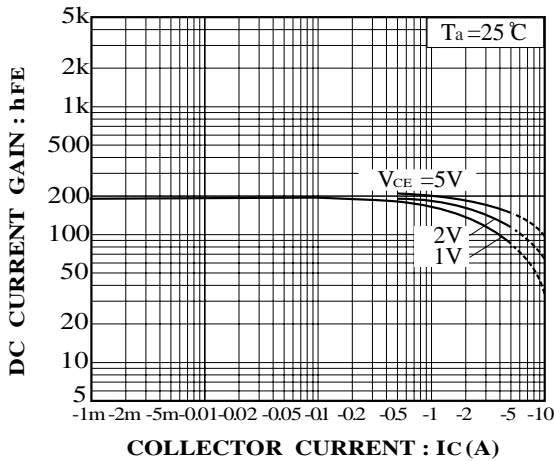
BASE TO EMITTER VOLTAGE :  $V_{BE}(V)$

**FIG.1 Grounded Emitter Propagation Characteristics**



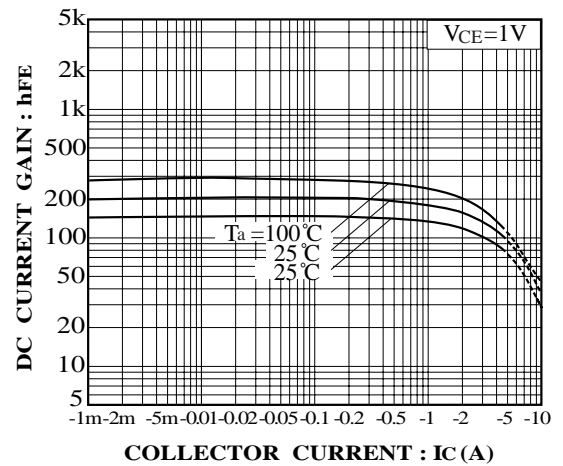
COLLECTOR TO EMITTER VOLTAGE :  $V_{CE}(V)$

**FIG.2 Grounded Emitter Output Characteristics**



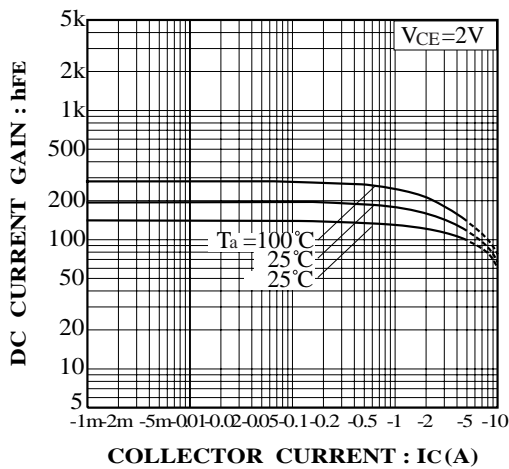
COLLECTOR CURRENT :  $I_C(A)$

**FIG.3 DC Current Gain vs. Collector Current**



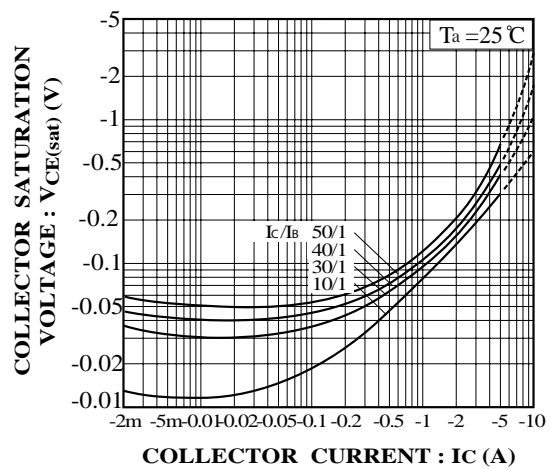
COLLECTOR CURRENT :  $I_C(A)$

**FIG.4 DC Current Gain vs. Collector Current**



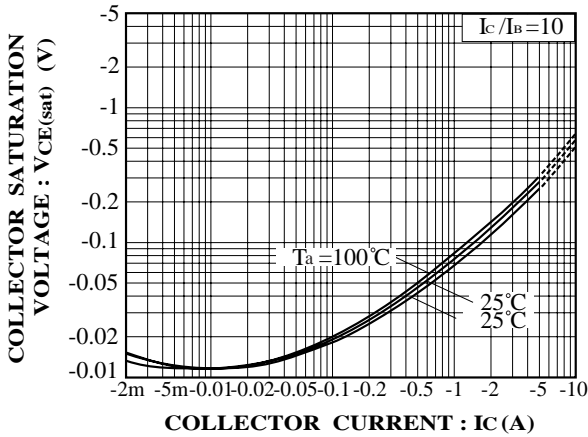
COLLECTOR CURRENT :  $I_C(A)$

**FIG.5 DC Current Gain vs. Collector Current**

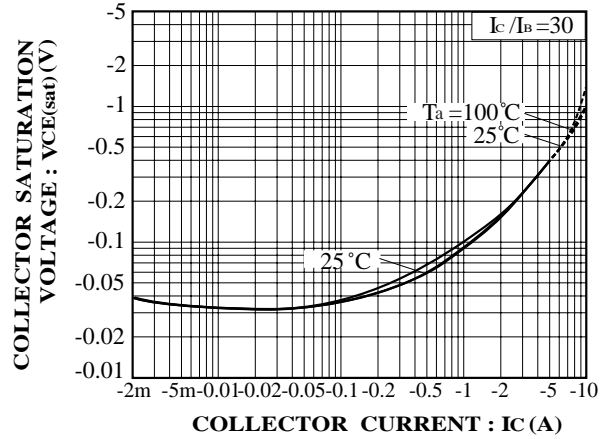


COLLECTOR CURRENT :  $I_C(A)$

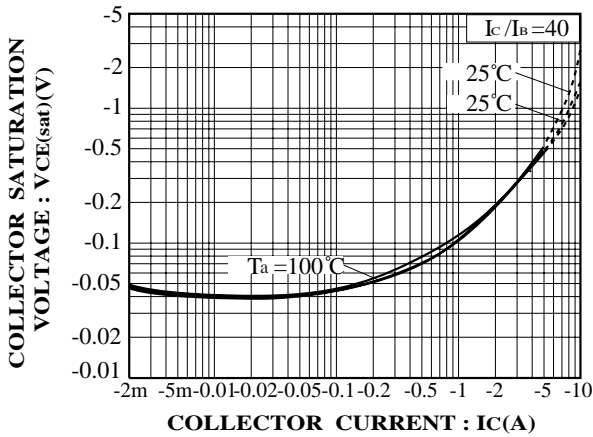
**FIG.6 Collector-Emmitter Saturation Voltage vs. Collector Current**



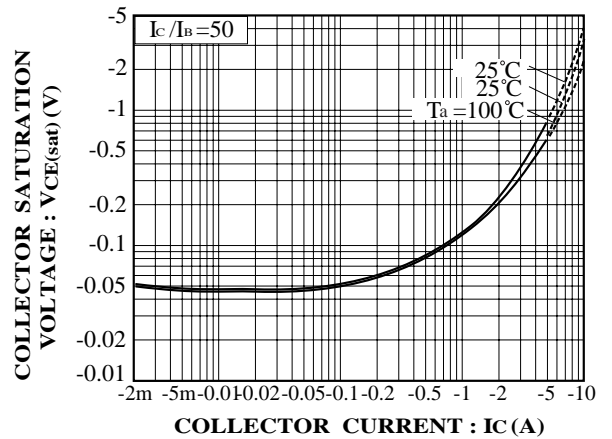
**FIG.7 Collector-Emitter Saturation Voltage vs. Collector Current**



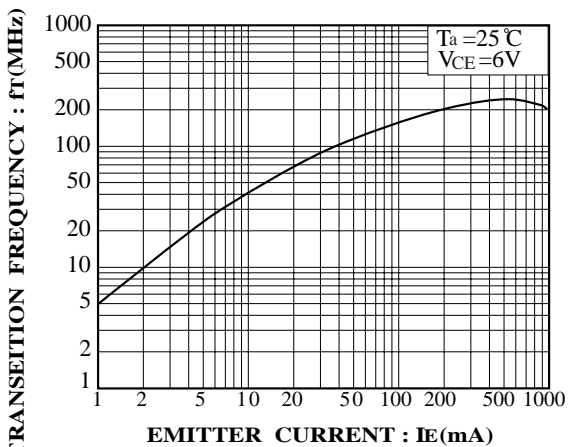
**FIG.8 Collector-Emitter Saturation Voltage vs. Collector Current**



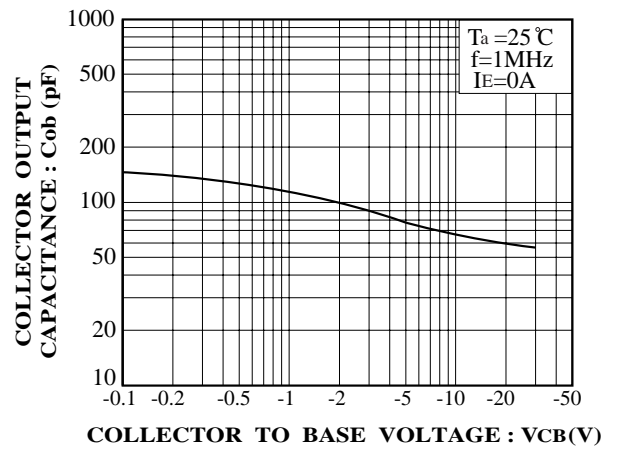
**FIG.9 Collector-Emitter Saturation Voltage vs. Collector Current**



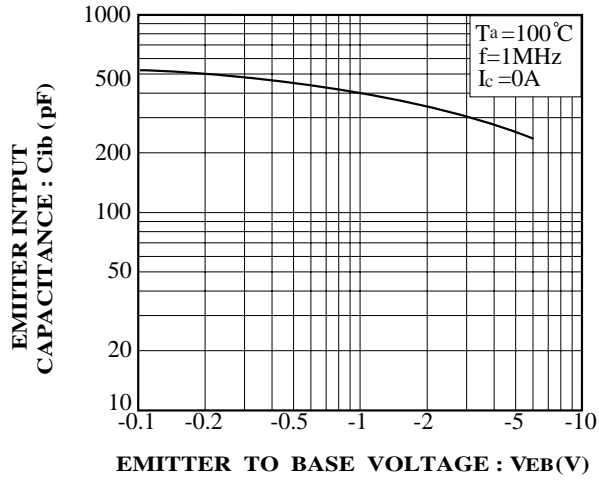
**FIG.10 Collector-Emitter Saturation Voltage vs. Collector Current**



**FIG.11 Gain Bandwidth Product vs. Emitter Current**



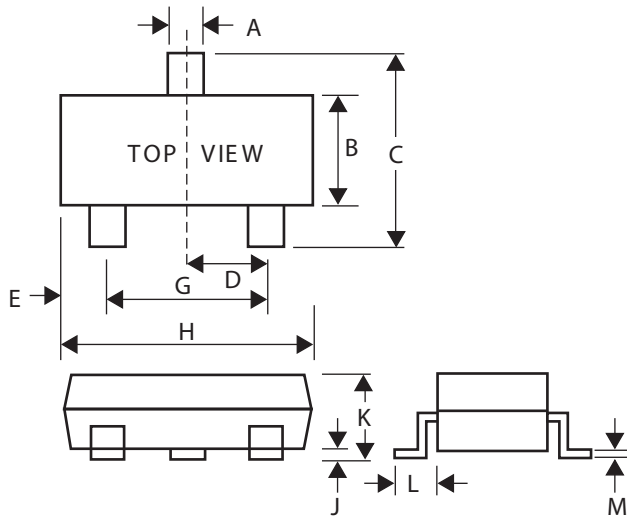
**FIG.12 Collector Output Capacitance vs. Collector-Base Voltage**



**FIG.13 Emitter Input Capacitance vs. Emitter-Base Voltage**

SOT-23 Package Outline Dimensions

Unit:mm



Dim	Min	Max
A	0.35	0.51
B	1.19	1.40
C	2.10	3.00
D	0.85	1.05
E	0.46	1.00
G	1.70	2.10
H	2.70	3.10
J	0.01	0.13
K	0.89	1.10
L	0.30	0.61
M	0.076	0.25